Fingerprint Imaging Sensor Product Data Sheet FIS- 3001

Overview

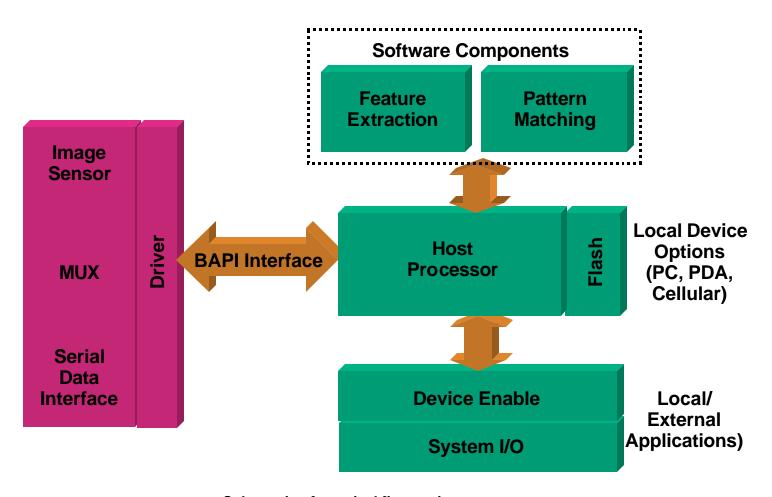
Features

Specifications

Applications

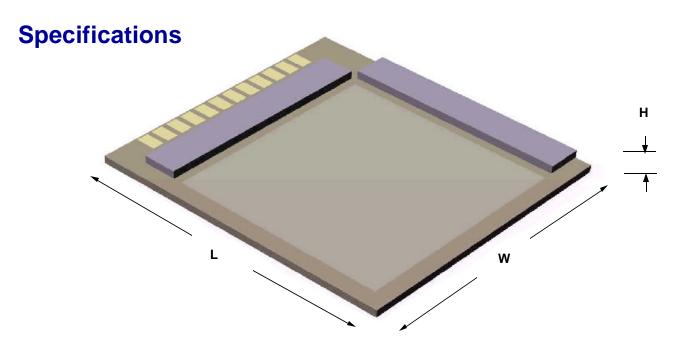
Overview

Fidelica develops and markets leading edge micro-pressure sensor technology. The first commercial application is designed to support fingerprint image capturing and comparison applications. The Fidelica Model FIS— 3001 (Fidelica Image Sensor model 3001) is designed to be embedded into microprocessor based devices. When integrated with applicable host components, this sensor enables users to perform a variety of local, remote, mobile and online electronic authentication security functions.



Schematic of a typical fingerprint recognition system

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Mechanical

Size overall

16.2mm W x 18.2mm L x 1.0mm H (.63 in. x .71 in. x .039 in.)

Sensor/image size

• 12.8mm x 12.8mm (0.5 in. x 0.5 in.) imaging area

Weight

• 2g

Sensor image resolution

• 508 dpi

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Specifications

Reliability

Temperature

Operating

Minimum: 0°C (32°F) Maximum: 60°C (140°F)

• Storage and shipping temperature

Minimum: -40°C (-40°F) Maximum: 65°C (149°F)

Humidity

• 5% to 95% non-condensing

Altitude

• Operating: 10,000 ft.

Shock

- Operating: 10g, 6ms, half sine wave
- Non-operating: 10g, 6ms, half sine wave

Vibration

• Operating: 11.69g (50-2000 Hz)

• Non-operating: 11.69g (50-2000 Hz)

Lifetime MTTF

 Touch surface life: 1,000,000+ touches (estimated life in excess of 5yrs)

Performance¹

- Scan time <1 second
- False Accept Rate (FAR) <.001%
- False Reject Rate (FRR) <.1%
- Bad cells in array <2%
- Bad rows and columns in array <2%, non adjacent

Interface

Serial data output/USB compatible

Notes:

1. FAR and FRR performance for this sensor release is <2% FRR at .001% FAR. Results were obtained from a randomly acquired image without considering angular position of the finger and the population (background, gender, occupation or age).

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Applications



Wireless



Workstations



PDA



Game Consoles



Physical Access



Law Enforcement



Features

Lowest power consumption in the industry Ideal for wireless applications Smaller than a postage stamp Pure binary image output **Sensor array is not based on CMOS** No image calibration necessary 508 dpi resolution Passive pressure sensing array

Benefits

Embeds into any mobile device Low software overhead **ESD** resistant Faster image acquisition time Conforms to FBI standard **Durable user interface**

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Contact

Fidelica Microsystems, Inc.

Corporate Headquarters 423 Dixon Landing Road Milpitas, CA 95035

Operations 75 Robin Hill Road Santa Barbara, CA 93117

Main: (408) 941-7900

Fax: (408) 941-8149

Email: marketing@fidelica.com sales@fidelica.com info@fidelica.com

Web: www.fidelica.com

